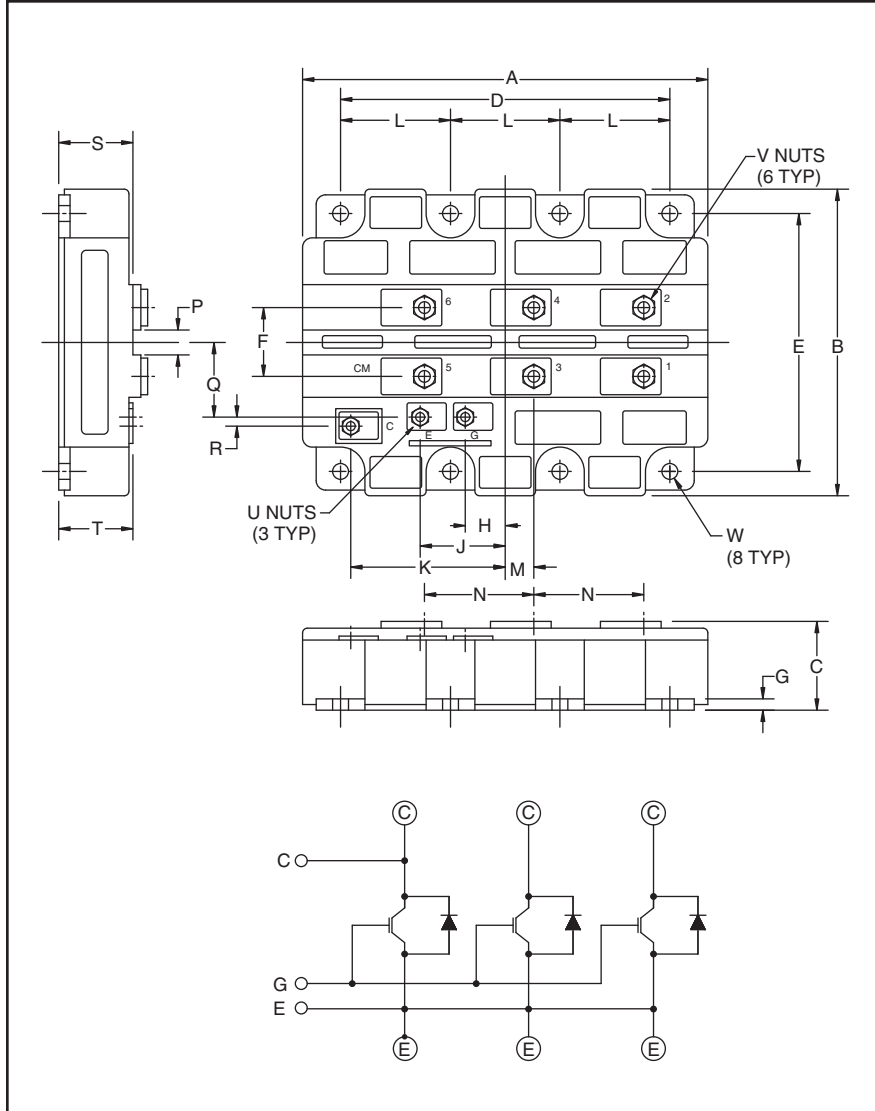


Single IGBTMOD™ HVIGBT Module 1500 Amperes/3300 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	7.48±0.02	190.0±0.5
B	5.51±0.02	140.0±0.5
C	1.50+0.04/-0.0	38.0+1.0/-0.0
D	6.73	171.0
E	4.88±0.01	124.0±0.25
F	1.57±0.012	40.0±0.3
G	0.20±0.012	5.0±0.3
H	0.80±0.012	20.25±0.3
J	1.62±0.012	41.25±0.3
K	3.13±0.012	79.4±0.3
L	2.24±0.01	57.0±0.25

Dimensions	Inches	Millimeters
M	0.51±0.012	13.0±0.3
N	2.42±0.012	61.5±0.3
P	0.59±0.012	15.0±0.3
Q	1.57±0.012	40.0±0.3
R	0.20±0.012	5.2±0.3
S	1.16±0.02	29.5±0.5
T	1.10±0.02	28.0±0.5
U	M4 Metric	M4
V	M8 Metric	M8
W	0.28 Dia.	Dia. 7.0



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of an IGBT Transistor and a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Super-Fast Recovery Free-Wheel Diode
- Isolated Baseplate for Easy Heat Sinking

Applications:

- Traction
- Pulsed Power
- Renewable Energy
- Medium Voltage Drives
- High Voltage Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM1500HB-66R is a 3300V (V_{CES}), 1500 Ampere Single IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	1500	66



Powerex, Inc., 173 Pavilion Lane, Youngwood, Pennsylvania 15697 (724) 925-7272

CM1500HC-66R
Single IGBTMOD™ HVIGBT Module
1500 Amperes/3300 Volts

Absolute Maximum Ratings, $T_j = 25\text{ °C}$ unless otherwise specified

Ratings	Symbol	CM1500HC-66R	Units
Junction Temperature	T_j	-40 to 150	°C
Storage Temperature	T_{stg}	-55 to 125	°C
Collector-Emitter Voltage ($V_{GE} = 0V, T_j = -40 \sim 125\text{°C}$)	V_{CES}	3300	Volts
Gate-Emitter Voltage ($V_{CE} = 0V$)	V_{GES}	± 20	Volts
Collector Current (DC, $T_c = 100\text{°C}$)	I_C	1500	Amperes
Peak Collector Current (Pulse)	I_{CM}	3000*	Amperes
Diode Forward Current** ($T_c = 25\text{°C}$)	I_E	1500	Amperes
Diode Forward Surge Current** (Pulse)	I_{EM}	3000*	Amperes
Maximum Short Circuit Pulse Width ($V_{CC} = 2500V, V_{CE} \leq V_{CES}, V_{GE} = 15V, T_j = 150\text{°C}$)	t_{psc}	10	μs
Maximum Collector Dissipation ($T_c = 25\text{°C}, T_j \leq 150\text{°C}$)	P_C	15600	Watts
Max. Mounting Torque M8 Terminal Screws	–	195	in-lb
Max. Mounting Torque M6 Mounting Screws	–	53	in-lb
Max. Mounting Torque M4 Auxiliary Terminal Screws	–	27	in-lb
Module Weight (Typical)	–	1.2	kg
V Isolation (Charged Part to Baseplate, AC 60Hz 1 min.)	V_{iso}	6000	Volts

* Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{op(max)}$ rating (150°C).

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

CM1500HC-66R
Single IGBTMOD™ HVIGBT Module
 1500 Amperes/3300 Volts

Static Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 25^\circ\text{C}$	–	–	5.0	mA	
		$V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 125^\circ\text{C}$	–	5.0	–	mA	
		$V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 150^\circ\text{C}$	–	18.0	–	mA	
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 150\text{mA}, V_{CE} = 10V$	5.5	6.0	6.5	Volts	
Gate Leakage Current	I_{GES}	$V_{GE} = V_{GES}, V_{CE} = 0V$	-0.5	–	0.5	μA	
Input Capacitance	C_{ies}		–	210.0	–	nF	
Output Capacitance	C_{oes}	$V_{GE} = 0V, V_{CE} = 10V, f = 100\text{ kHz}$	–	13.0	–	nF	
Reverse Transfer Capacitance	C_{res}		–	6.0	–	nF	
Total Gate Charge	Q_G	$V_{CC} = 1800V, I_C = 1500A, V_{GE} = \pm 15V$	–	16.0	–	μC	
Internal Gate Resistor	r_G		–	1.5	–	Ω	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}^*$	$I_C = 1500A, V_{GE} = 15V, T_j = 25^\circ\text{C}$	–	2.5	–	Volts	
		$I_C = 1500A, V_{GE} = 15V, T_j = 125^\circ\text{C}$	–	3.0	–	Volts	
		$I_C = 1500A, V_{GE} = 15V, T_j = 150^\circ\text{C}$	–	3.10	–	Volts	
Emitter-Collector Voltage**	V_{EC}^*	$I_E = 1500A, V_{GE} = 0V, T_j = 25^\circ\text{C}$	–	2.15	–	Volts	
		$I_E = 1500A, V_{GE} = 0V, T_j = 125^\circ\text{C}$	–	2.30	–	Volts	
		$I_E = 1500A, V_{GE} = 0V, T_j = 150^\circ\text{C}$	–	2.25	–	Volts	
Resistive	Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 1800V, I_C = 1500A,$	–	1.0	–	μs
Load	Turn-on Rise Time	t_r	$V_{GE} = \pm 15V, R_{G(on)} = 1.6\Omega,$	–	0.25	–	μs
Switching	Turn-on Switching Energy	$E_{on(10\%)}$	$T_j = 25^\circ\text{C}, L_s = 100\text{nH}$	–	2.1	–	J/Pulse
	Turn-on Switching Energy	E_{on}		–	2.4	–	J/Pulse
Resistive	Turn-off Delay Time	$t_{d(off)}$	$V_{CC} = 1800V, I_C = 1500A,$	–	2.7	–	μs
Load	Turn-off Fall Time	t_f	$V_{GE} = 15V, R_{G(off)} = 5.6\Omega,$	–	0.3	–	μs
Switching	Turn-off Switching Energy	$E_{off(10\%)}$	$T_j = 25^\circ\text{C}, L_s = 100\text{nH}$	–	1.85	–	J/Pulse
	Turn-off Switching Energy	E_{off}		–	2.05	–	J/Pulse
Reverse Recovery Time	t_{rr}			–	0.55	–	μs
Reverse Recovery Current	I_{rr}	$V_{CC} = 1800V, I_C = 1500A,$	–	1400	–	A	
Reverse Recovery Charge	Q_{rr}	$V_{GE} = \pm 15V, R_{G(on)} = 1.6\Omega,$	–	1100	–	μC	
Reverse Recovery Energy	$E_{rec(10\%)}$	$T_j = 25^\circ\text{C}, L_s = 100\text{nH}$	–	1.15	–	J/Pulse	
Reverse Recovery Energy	E_{rec}		–	1.25	–	J/Pulse	

* Pulse width and repetition rate should be such that device junction temperature rise is negligible.



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CM1500HC-66R
Single IGBTMOD™ HVIGBT Module
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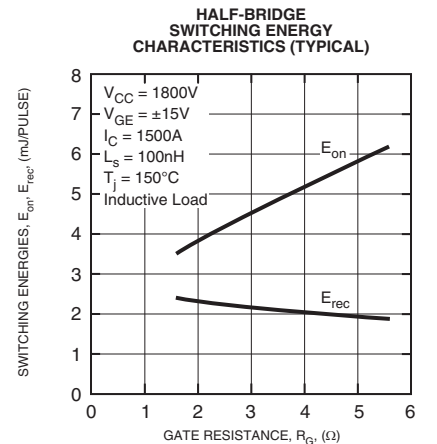
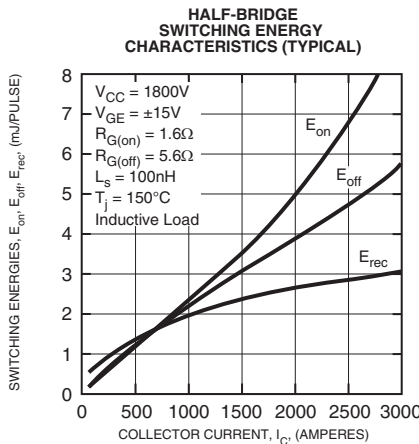
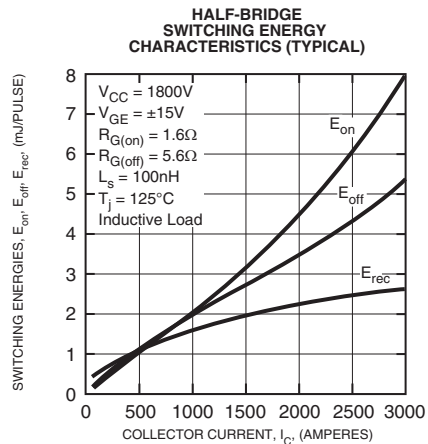
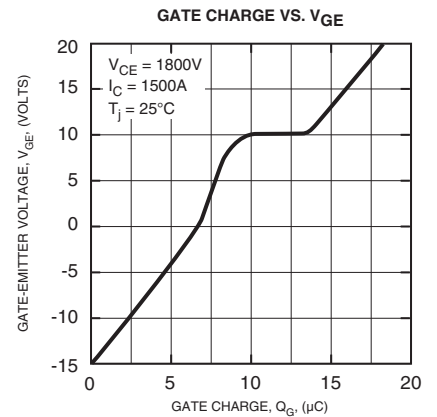
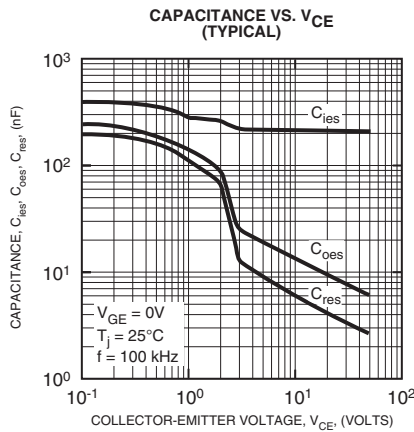
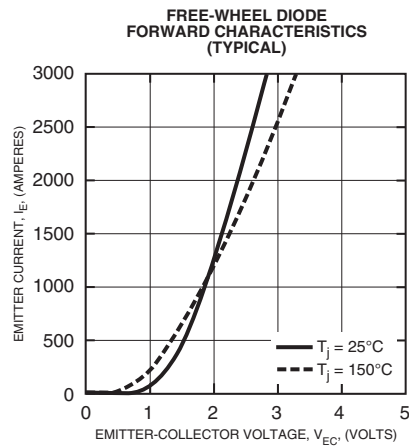
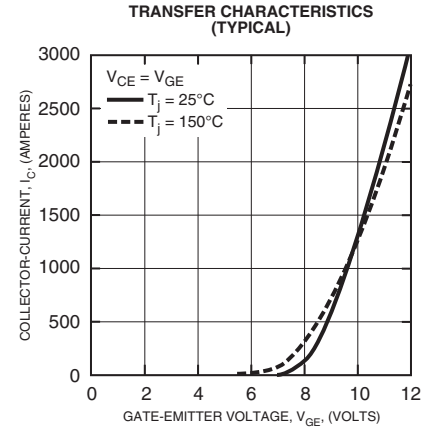
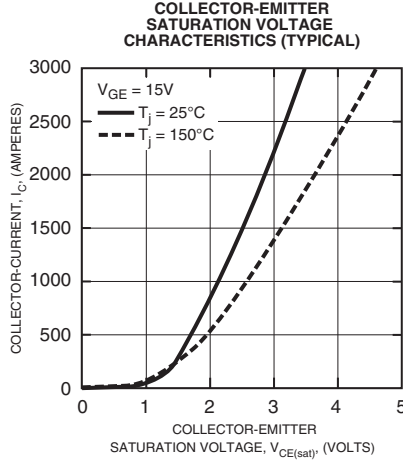
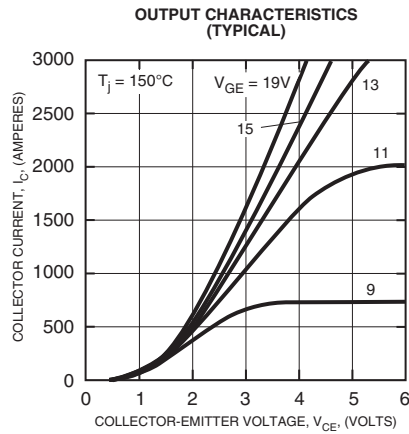
Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics		Symbol	Test Conditions	Min.	Typ.	Max.	Units
Resistive	Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 1800V, I_C = 1500A,$	–	1.0	–	μs
Load	Turn-on Rise Time	t_r	$V_{GE} = \pm 15V, R_{G(on)} = 1.6\Omega,$	–	0.26	–	μs
Switching	Turn-on Switching Energy	$E_{on(10\%)}$	$T_j = 125^\circ C, L_S = 100nH$	–	2.8	–	J/Pulse
Times	Turn-on Switching Energy	E_{on}		–	3.1	–	J/Pulse
Resistive	Turn-off Delay Time	$t_{d(off)}$	$V_{CC} = 1800V, I_C = 1500A,$	–	2.8	–	μs
Load	Turn-off Rise Time	t_r	$V_{GE} = \pm 15V, R_{G(off)} = 5.6\Omega,$	–	0.35	–	μs
Switching	Turn-off Switching Energy	$E_{off(10\%)}$	$T_j = 125^\circ C, L_S = 100nH$	–	2.4	–	J/Pulse
Times	Turn-off Switching Energy	E_{off}		–	2.7	–	J/Pulse
Reverse Recovery Time		t_{rr}		–	0.75	–	μs
Reverse Recovery Current		I_{rr}	$V_{CC} = 1800V, I_C = 1500A,$	–	1600	–	A
Reverse Recovery Charge		Q_{rr}	$V_{GE} = \pm 15V, R_{G(on)} = 1.6\Omega,$	–	1700	–	μC
Reverse Recovery Energy		$E_{rec(10\%)}$	$T_j = 125^\circ C, L_S = 100nH$	–	1.85	–	J/Pulse
Reverse Recovery Energy		E_{rec}		–	2.00	–	J/Pulse
Resistive	Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 1800V, I_C = 1500A,$	–	1.0	–	μs
Load	Turn-on Rise Time	t_r	$V_{GE} = \pm 15V, R_{G(on)} = 1.6\Omega,$	–	0.26	–	μs
Switching	Turn-on Switching Energy	$E_{on(10\%)}$	$T_j = 150^\circ C, L_S = 100nH$	–	2.9	–	J/Pulse
Times	Turn-on Switching Energy	E_{on}		–	3.5	–	J/Pulse
Resistive	Turn-off Delay Time	$t_{d(off)}$	$V_{CC} = 1800V, I_C = 1500A,$	–	2.9	–	μs
Load	Turn-off Rise Time	t_r	$V_{GE} = \pm 15V, R_{G(off)} = 5.6\Omega,$	–	0.4	–	μs
Switching	Turn-off Switching Energy	$E_{off(10\%)}$	$T_j = 150^\circ C, L_S = 100nH$	–	2.65	–	J/Pulse
Times	Turn-off Switching Energy	E_{off}		–	3.00	–	J/Pulse
Reverse Recovery Time		t_{rr}		–	0.8	–	μs
Reverse Recovery Current		I_{rr}	$V_{CC} = 1800V, I_C = 1500A,$	–	1600	–	A
Reverse Recovery Charge		Q_{rr}	$V_{GE} = \pm 15V, R_{G(on)} = 1.6\Omega,$	–	2000	–	μC
Reverse Recovery Energy		$E_{rec(10\%)}$	$T_j = 150^\circ C, L_S = 100nH$	–	2.2	–	J/Pulse
Reverse Recovery Energy		E_{rec}		–	2.4	–	J/Pulse

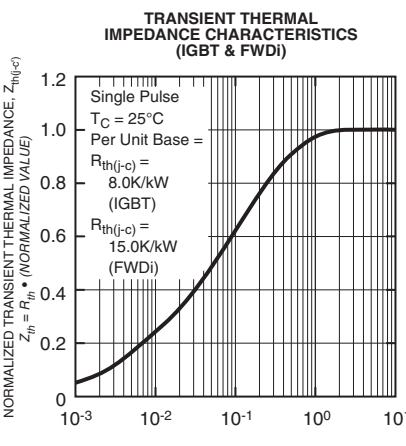
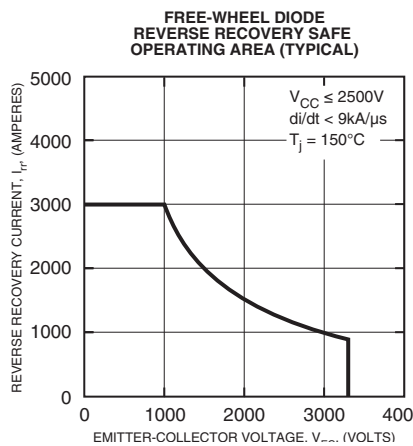
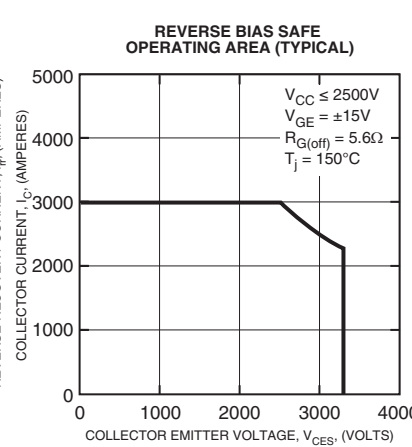
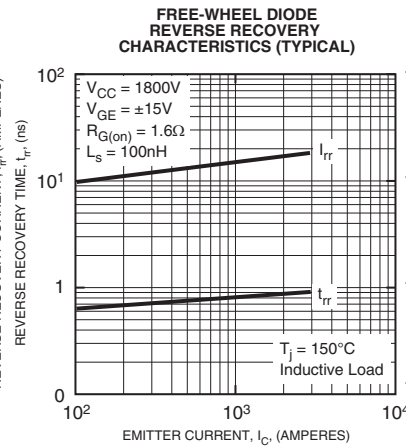
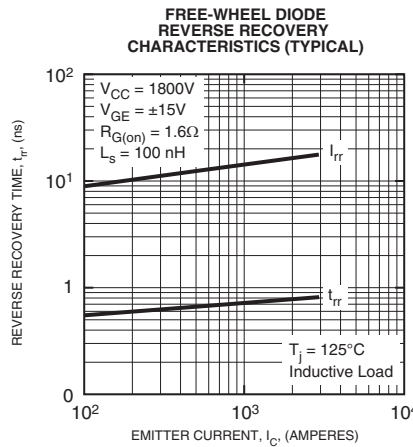
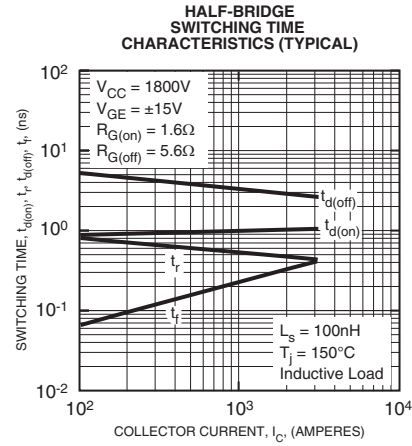
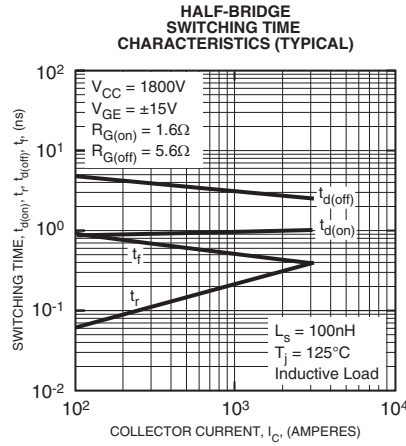
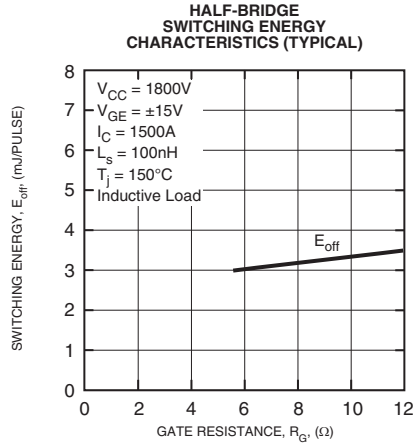
Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)} Q$		–	–	8.0	K/W
Thermal Resistance, Junction to Case	$R_{th(j-c)} D$		–	–	15.0	K/W
Contact Thermal Resistance, Case to Fin	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	6.0	–	K/W
Comparative Tracking Index	CTI		600	–	–	
Clearance	D_{cl}		19.5	–	–	mm
Creepage Distance	D_{cr}		32.0	–	–	mm
Internal Inductance	$L_{C-E(int)}$		–	11.0	–	nH
Internal Lead Resistance	$R_{C-E(int)}$		–	0.12	–	m Ω

CM1500HC-66R
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$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i \left(1 - \exp\left(-\frac{t}{\tau_i}\right) \right)$$

	1	2	3	4
R_i [K/kW]:	0.0096	0.1893	0.4044	0.3967
t_i [sec]:	0.0001	0.0058	0.0602	0.3512